

50. The process of Claim 47 wherein said web substrate is ITO/PET coated with a positive photoresist.

51. The process of Claim 49 wherein the positive photoresist is developed after exposure and the conductor layer/plastic substrate is etched to expose discrete patterns.

52. The process of Claim 51 wherein the photoresist is stripped.

REMARKS

Applicants have added claims 46-52. These claims are supported by the disclosures such as the sections on page 6, lines 12-14, page 5, lines 1-3, page 28, lines 19-20, page 4, lines 18-19, and page 10, lines 7-9.

Applicants submit that the pending claims are directed to allowable subject matter, and respectfully request consideration and allowance of the application.

The Commissioner is hereby authorized to charge any additional fees and to credit any overpayment which may be required with this communication under 37 CFR §§1.16 and 1.17, to Deposit Account No. 08-1641, referencing Attorney's Docket No. 26822-0006.

Respectfully submitted,

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